

PRELIMINARY

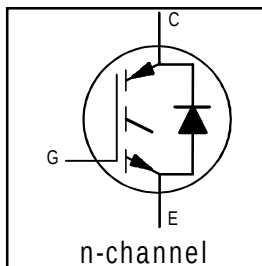
# IRG4IBC20UD

INSULATED GATE BIPOLAR TRANSISTOR WITH  
ULTRAFAST SOFT RECOVERY DIODE

UltraFast CoPack IGBT

## Features

- 2.5kV, 60s insulation voltage ⑤
- 4.8 mm creepage distance to heatsink
- UltraFast: Optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes
- Tighter parameter distribution
- Industry standard Isolated TO-220 Fullpak™ outline



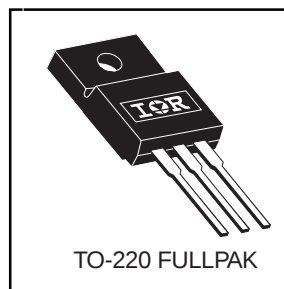
$$V_{CES} = 600V$$

$$V_{CE(on)} \text{ typ.} = 1.85V$$

$$@V_{GE} = 15V, I_C = 6.5A$$

## Benefits

- Simplified assembly
- Highest efficiency and power density
- HEXFRED™ antiparallel Diode minimizes switching losses and EMI



## Absolute Maximum Ratings

|                           | Parameter                                | Max.                              | Units      |
|---------------------------|------------------------------------------|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage             | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current             | 11.4                              | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current             | 6.0                               |            |
| $I_{CM}$                  | Pulsed Collector Current ①               | 52                                |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②         | 52                                |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current         | 6.5                               |            |
| $I_{FM}$                  | Diode Maximum Forward Current            | 52                                |            |
| $V_{isol}$                | RMS Isolation Voltage, Terminal to Case⑤ | 2500                              | V          |
| $V_{GE}$                  | Gate-to-Emitter Voltage                  | $\pm 20$                          | W          |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                | 34                                |            |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                | 14                                |            |
| $T_J$                     | Operating Junction and                   | -55 to +150                       |            |
| $T_{STG}$                 | Storage Temperature Range                |                                   | $^\circ C$ |
|                           | Soldering Temperature, for 10 sec.       | 300 (0.063 in. (1.6mm) from case) |            |
|                           | Mounting Torque, 6-32 or M3 Screw.       | 10 lbf•in (1.1 N•m)               |            |

## Thermal Resistance

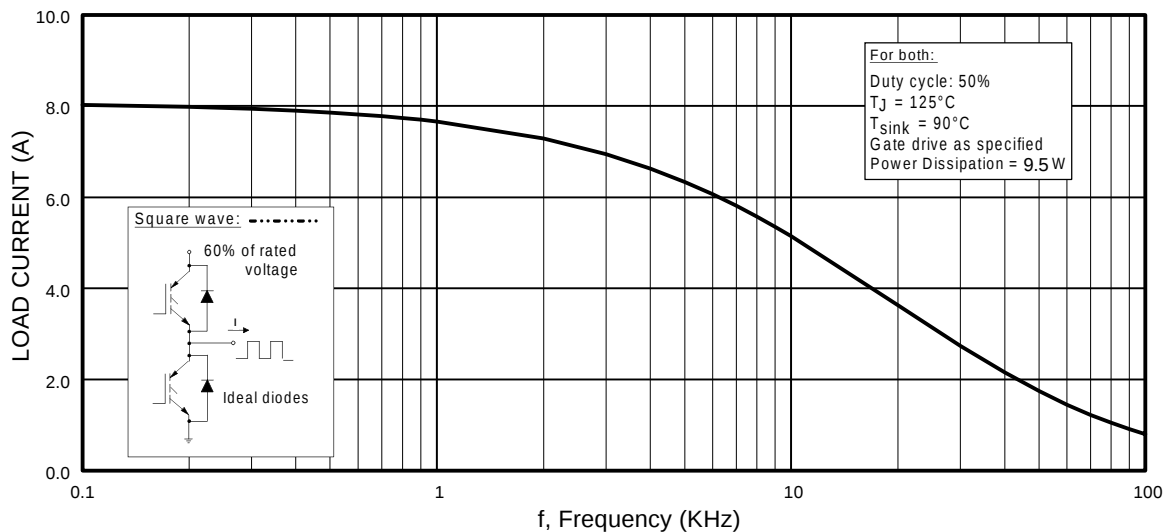
|                 | Parameter                                 | Typ.       | Max. | Units        |
|-----------------|-------------------------------------------|------------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —          | 3.7  | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | —          | 5.1  |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —          | 65   |              |
| $W_t$           | Weight                                    | 2.0 (0.07) | —    | g (oz)       |

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

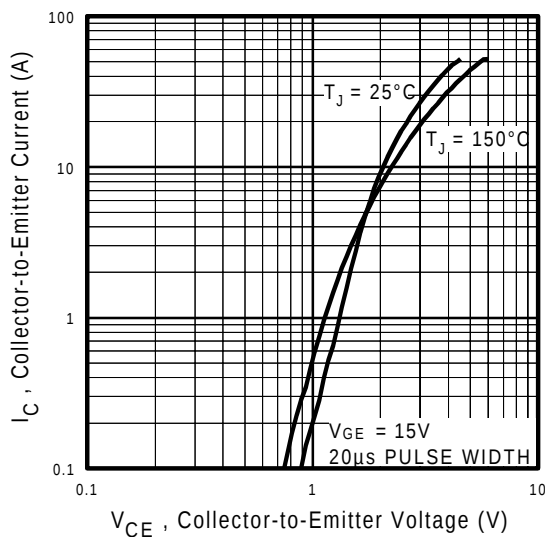
|                                 | Parameter                                           | Min. | Typ. | Max.      | Units                | Conditions                                                  |
|---------------------------------|-----------------------------------------------------|------|------|-----------|----------------------|-------------------------------------------------------------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | —    | —         | V                    | $V_{GE} = 0V$ , $I_C = 250\mu A$                            |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage             | —    | 0.69 | —         | V/ $^\circ\text{C}$  | $V_{GE} = 0V$ , $I_C = 1.0mA$                               |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage             | —    | 1.85 | 2.1       | V                    | $I_C = 6.5A$ $V_{GE} = 15V$                                 |
|                                 |                                                     | —    | 2.27 | —         |                      | $I_C = 13A$ See Fig. 2, 5                                   |
|                                 |                                                     | —    | 1.87 | —         |                      | $I_C = 6.5A$ , $T_J = 150^\circ\text{C}$                    |
| $V_{GE(th)}$                    | Gate Threshold Voltage                              | 3.0  | —    | 6.0       |                      | $V_{CE} = V_{GE}$ , $I_C = 250\mu A$                        |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage             | —    | -11  | —         | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}$ , $I_C = 250\mu A$                        |
| $g_{fe}$                        | Forward Transconductance <sup>④</sup>               | 1.4  | 4.3  | —         | S                    | $V_{CE} = 100V$ , $I_C = 6.5A$                              |
| $I_{CES}$                       | Zero Gate Voltage Collector Current                 | —    | —    | 250       | $\mu A$              | $V_{GE} = 0V$ , $V_{CE} = 600V$                             |
|                                 |                                                     | —    | —    | 1700      |                      | $V_{GE} = 0V$ , $V_{CE} = 600V$ , $T_J = 150^\circ\text{C}$ |
| $V_{FM}$                        | Diode Forward Voltage Drop                          | —    | 1.4  | 1.7       | V                    | $I_C = 8.0A$ See Fig. 13                                    |
|                                 |                                                     | —    | 1.3  | 1.6       |                      | $I_C = 8.0A$ , $T_J = 150^\circ\text{C}$                    |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current                     | —    | —    | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                          |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

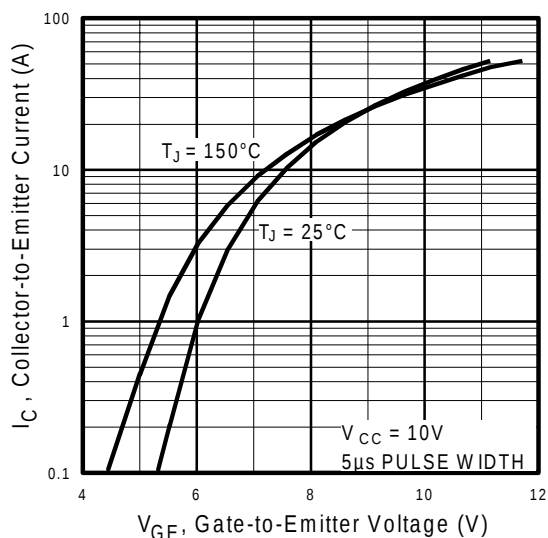
|                  | Parameter                                        | Min. | Typ. | Max. | Units      | Conditions                                                                                                                                                                            |
|------------------|--------------------------------------------------|------|------|------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $Q_g$            | Total Gate Charge (turn-on)                      | —    | 27   | 41   | nC         | $I_C = 6.5A$<br>$V_{CC} = 400V$ See Fig. 8<br>$V_{GE} = 15V$                                                                                                                          |
| $Q_{ge}$         | Gate - Emitter Charge (turn-on)                  | —    | 4.5  | 6.8  |            |                                                                                                                                                                                       |
| $Q_{gc}$         | Gate - Collector Charge (turn-on)                | —    | 10   | 16   |            |                                                                                                                                                                                       |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 39   | —    | ns         | $T_J = 25^\circ\text{C}$<br>$I_C = 6.5A$ , $V_{CC} = 480V$<br>$V_{GE} = 15V$ , $R_G = 50\Omega$<br>Energy losses include "tail" and diode reverse recovery.<br>See Fig. 9, 10, 11, 18 |
| $t_r$            | Rise Time                                        | —    | 15   | —    |            |                                                                                                                                                                                       |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 93   | 140  |            |                                                                                                                                                                                       |
| $t_f$            | Fall Time                                        | —    | 110  | 170  |            |                                                                                                                                                                                       |
| $E_{on}$         | Turn-On Switching Loss                           | —    | 0.16 | —    | mJ         | $T_J = 150^\circ\text{C}$ , See Fig. 9, 10, 11, 18<br>$I_C = 6.5A$ , $V_{CC} = 480V$<br>$V_{GE} = 15V$ , $R_G = 50\Omega$<br>Energy losses include "tail" and diode reverse recovery. |
| $E_{off}$        | Turn-Off Switching Loss                          | —    | 0.13 | —    |            |                                                                                                                                                                                       |
| $E_{ts}$         | Total Switching Loss                             | —    | 0.29 | 0.3  |            |                                                                                                                                                                                       |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 38   | —    | ns         | $T_J = 150^\circ\text{C}$ , See Fig. 9, 10, 11, 18<br>$I_C = 6.5A$ , $V_{CC} = 480V$<br>$V_{GE} = 15V$ , $R_G = 50\Omega$<br>Energy losses include "tail" and diode reverse recovery. |
| $t_r$            | Rise Time                                        | —    | 17   | —    |            |                                                                                                                                                                                       |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 100  | —    |            |                                                                                                                                                                                       |
| $t_f$            | Fall Time                                        | —    | 220  | —    |            |                                                                                                                                                                                       |
| $E_{ts}$         | Total Switching Loss                             | —    | 0.49 | —    | mJ         | Measured 5mm from package                                                                                                                                                             |
| $L_E$            | Internal Emitter Inductance                      | —    | 7.5  | —    | nH         |                                                                                                                                                                                       |
| $C_{ies}$        | Input Capacitance                                | —    | 530  | —    | pF         | $V_{GE} = 0V$<br>$V_{CC} = 30V$ See Fig. 7<br>$f = 1.0MHz$                                                                                                                            |
| $C_{oes}$        | Output Capacitance                               | —    | 39   | —    |            |                                                                                                                                                                                       |
| $C_{res}$        | Reverse Transfer Capacitance                     | —    | 7.4  | —    |            |                                                                                                                                                                                       |
| $t_{rr}$         | Diode Reverse Recovery Time                      | —    | 37   | 55   | ns         | $T_J = 25^\circ\text{C}$ See Fig. 14                                                                                                                                                  |
|                  |                                                  | —    | 55   | 90   |            | $T_J = 125^\circ\text{C}$                                                                                                                                                             |
| $I_{rr}$         | Diode Peak Reverse Recovery Current              | —    | 3.5  | 5.0  | A          | $T_J = 25^\circ\text{C}$ See Fig. 15                                                                                                                                                  |
|                  |                                                  | —    | 4.5  | 8.0  |            | $T_J = 125^\circ\text{C}$                                                                                                                                                             |
| $Q_{rr}$         | Diode Reverse Recovery Charge                    | —    | 65   | 138  | nC         | $T_J = 25^\circ\text{C}$ See Fig. 16                                                                                                                                                  |
|                  |                                                  | —    | 124  | 360  |            | $T_J = 125^\circ\text{C}$                                                                                                                                                             |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 240  | —    | A/ $\mu s$ | $T_J = 25^\circ\text{C}$ See Fig. 17                                                                                                                                                  |
|                  |                                                  | —    | 210  | —    |            | $T_J = 125^\circ\text{C}$                                                                                                                                                             |



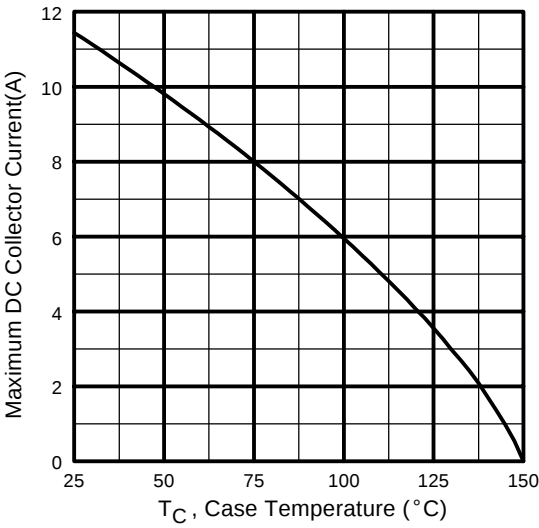
**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{\text{RMS}}$  of fundamental)



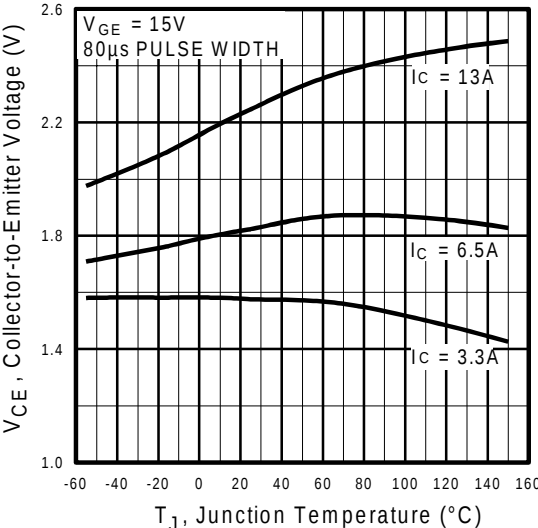
**Fig. 2 - Typical Output Characteristics**



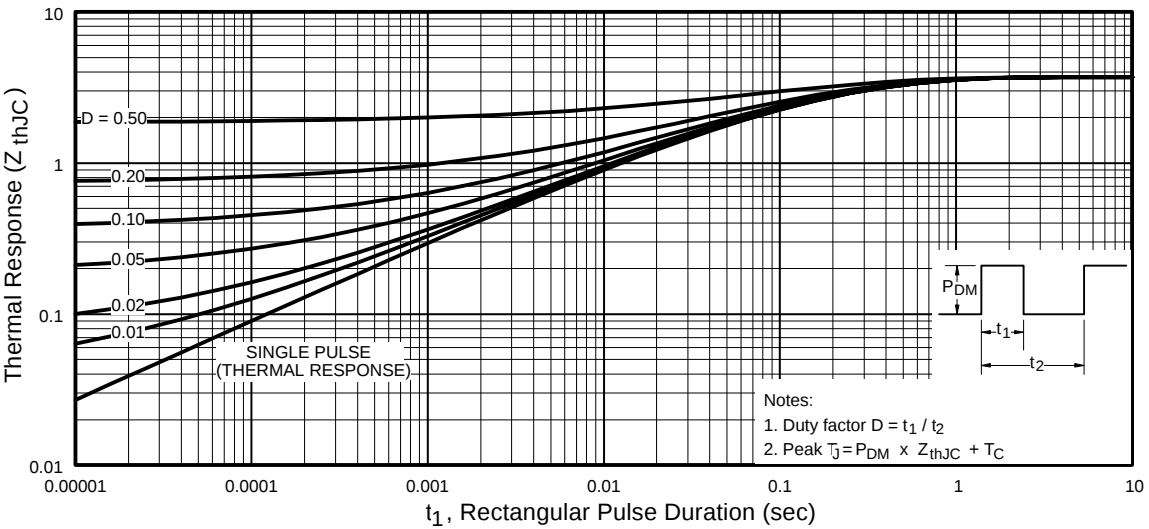
**Fig. 3 - Typical Transfer Characteristics**



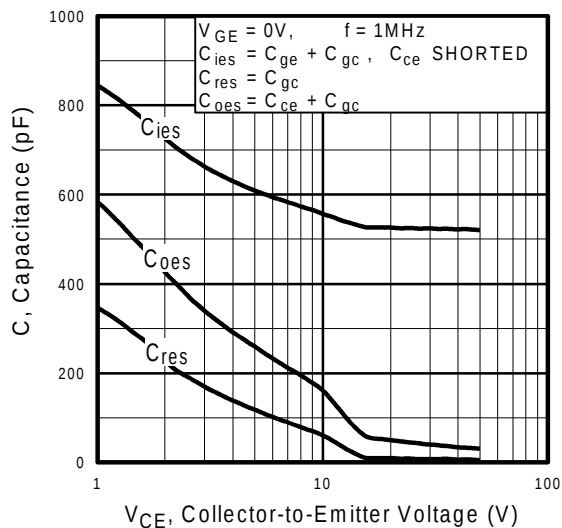
**Fig. 4** - Maximum Collector Current vs. Case Temperature



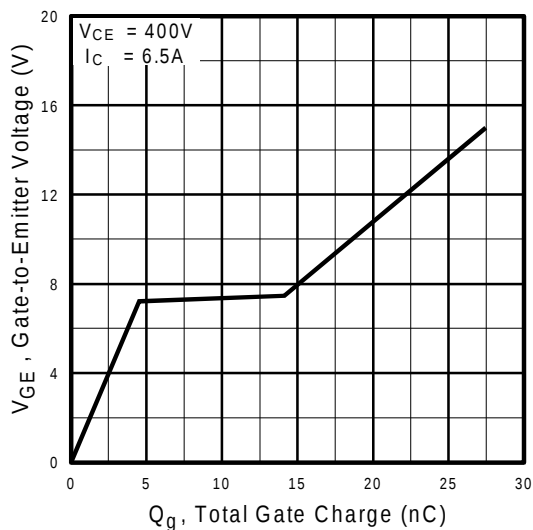
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



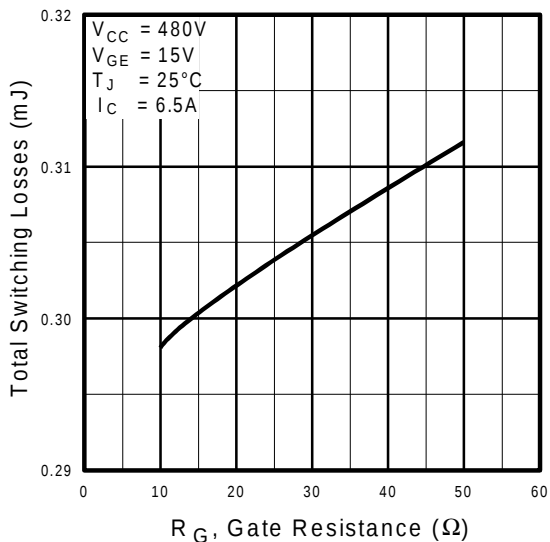
**Fig. 6** - Maximum IGBT Effective Transient Thermal Impedance, Junction-to-Case



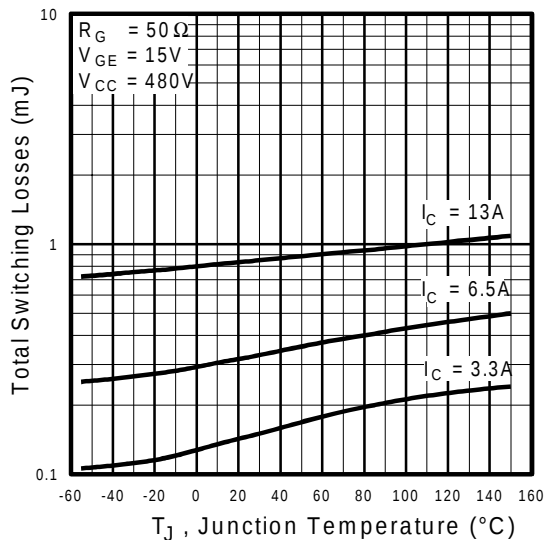
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage

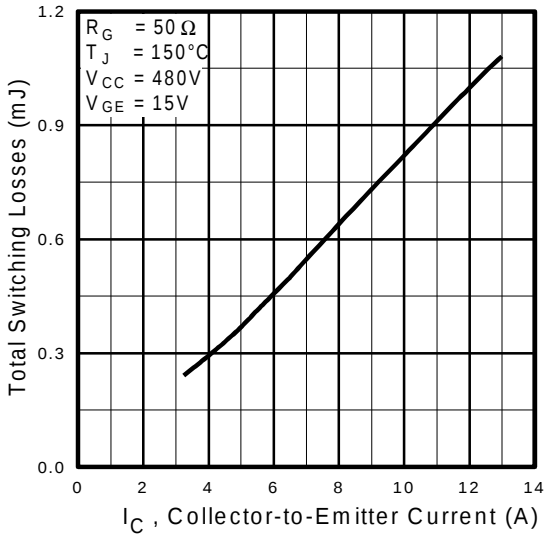


**Fig. 9** - Typical Switching Losses vs. Gate Resistance

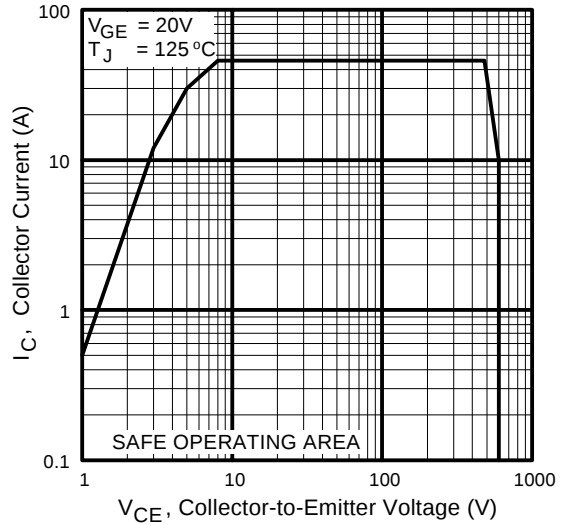


**Fig. 10** - Typical Switching Losses vs. Junction Temperature

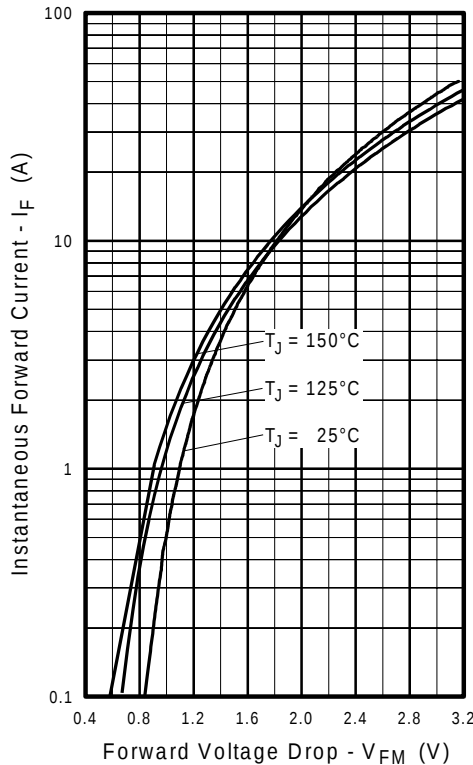
# IRG4IBC20UD



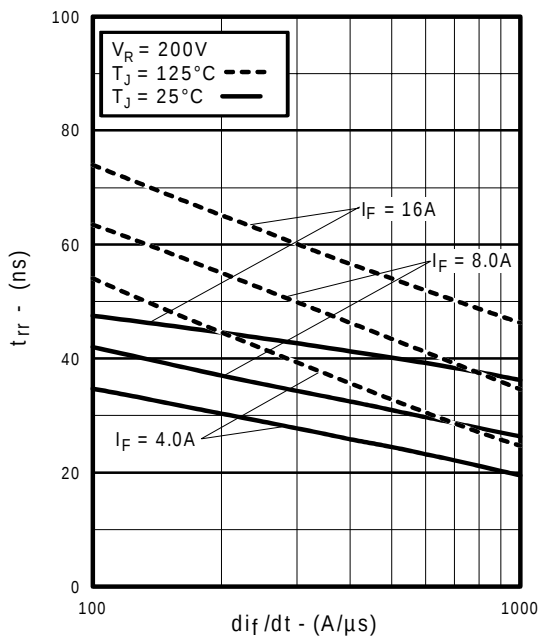
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



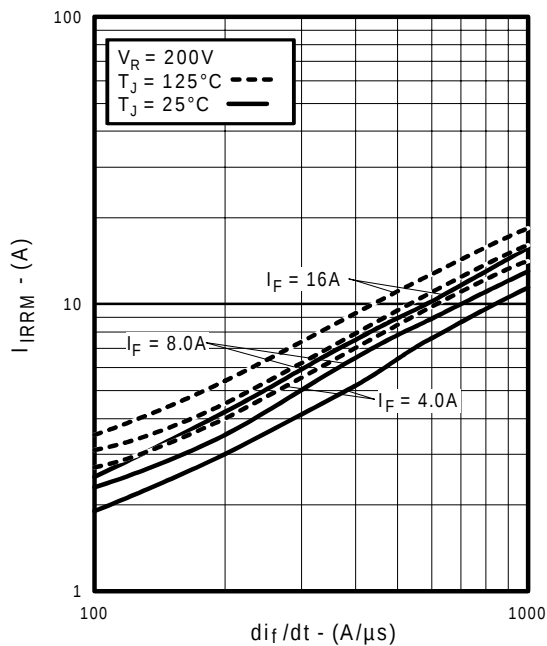
**Fig. 12** - Turn-Off SOA



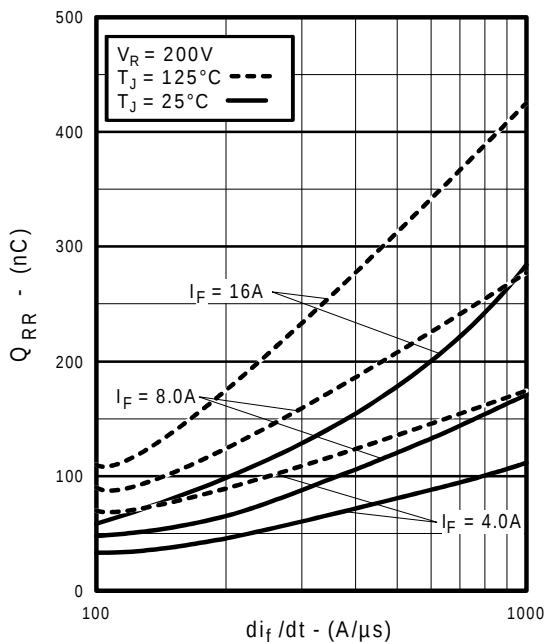
**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current



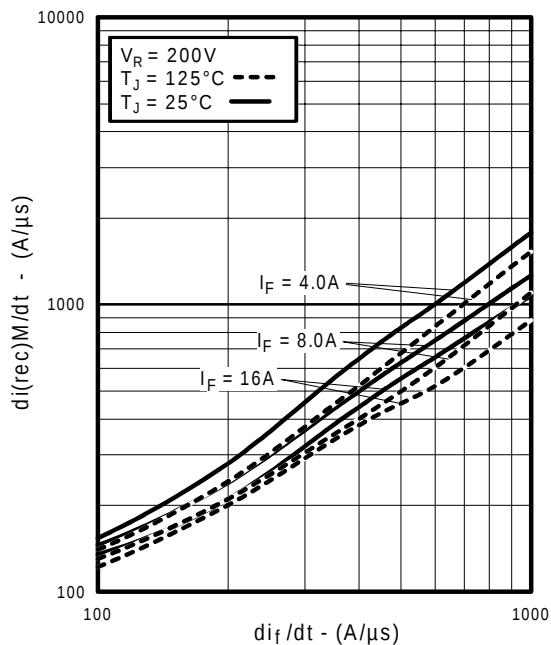
**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$



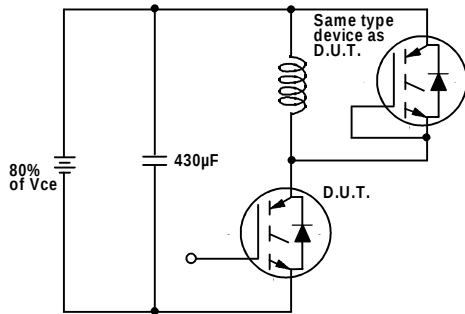
**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$



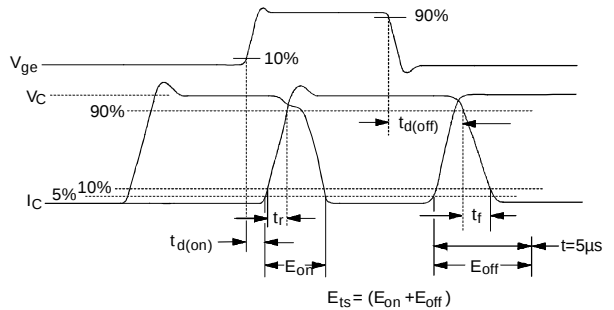
**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$



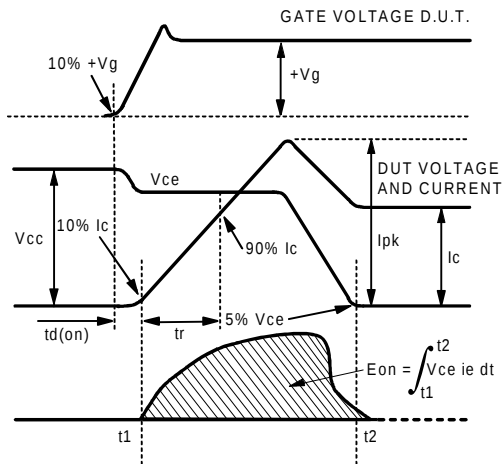
**Fig. 17** - Typical  $di_{(rec)}M/dt$  vs.  $di_f/dt$



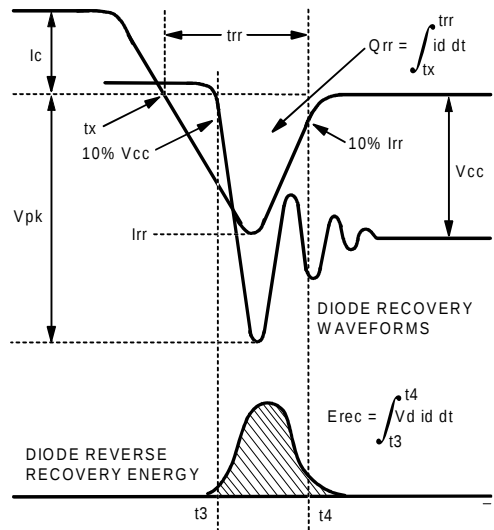
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

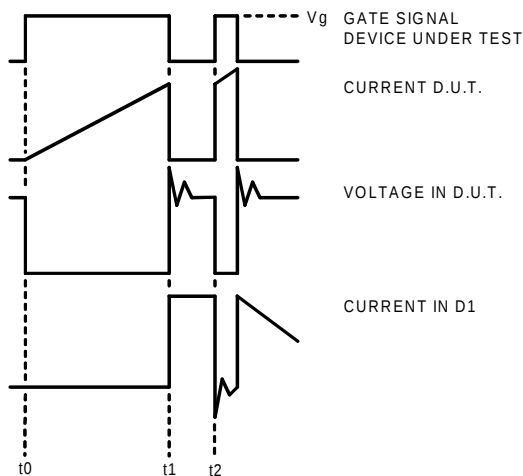


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

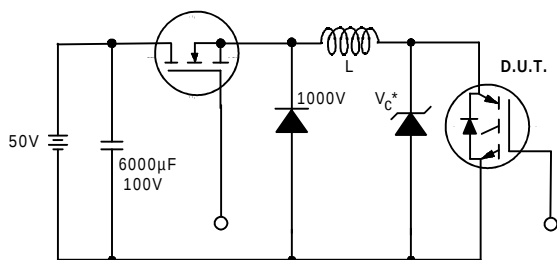


Figure 19. Clamped Inductive Load Test Circuit

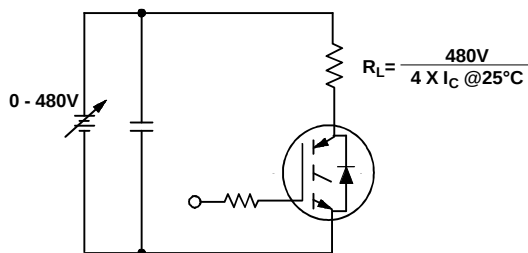


Figure 20. Pulsed Collector Current Test Circuit

## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\%(V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G = 50\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.
- ⑤  $t = 60s$ ,  $f = 60Hz$

## Case Outline — TO-220 FULLPAK

